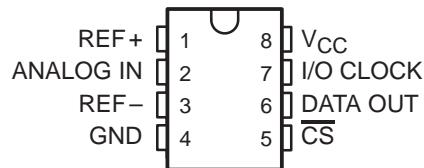


**TLC548C, TLC548I, TLC549C, TLC549I**  
**8-BIT ANALOG-TO-DIGITAL CONVERTERS**  
**WITH SERIAL CONTROL**

SLAS067C – NOVEMBER 1983 – REVISED SEPTEMBER 1996

- Microprocessor Peripheral or Standalone Operation
- 8-Bit Resolution A/D Converter
- Differential Reference Input Voltages
- Conversion Time . . . 17  $\mu$ s Max
- Total Access and Conversion Cycles Per Second
  - TLC548 . . . up to 45 500
  - TLC549 . . . up to 40 000
- On-Chip Software-Controllable Sample-and-Hold Function
- Total Unadjusted Error . . .  $\pm 0.5$  LSB Max
- 4-MHz Typical Internal System Clock
- Wide Supply Range . . . 3 V to 6 V
- Low Power Consumption . . . 15 mW Max
- Ideal for Cost-Effective, High-Performance Applications including Battery-Operated Portable Instrumentation
- Pinout and Control Signals Compatible With the TLC540 and TLC545 8-Bit A/D Converters and with the TLC1540 10-Bit A/D Converter
- CMOS Technology

**D OR P PACKAGE  
(TOP VIEW)**



### description

The TLC548 and TLC549 are CMOS analog-to-digital converter (ADC) integrated circuits built around an 8-bit switched-capacitor successive-approximation ADC. These devices are designed for serial interface with a microprocessor or peripheral through a 3-state data output and an analog input. The TLC548 and TLC549 use only the input/output clock (I/O CLOCK) input along with the chip select (CS) input for data control. The maximum I/O CLOCK input frequency of the TLC548 is 2.048 MHz, and the I/O CLOCK input frequency of the TLC549 is specified up to 1.1 MHz.

### AVAILABLE OPTIONS

T <sub>A</sub>	PACKAGE	
	SMALL OUTLINE (D)	PLASTIC DIP (P)
0°C to 70°C	TLC548CD TLC549CD	TLC548CP TLC549CP
–40°C to 85°C	TLC548ID TLC549ID	TLC548IP TLC549IP



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

Copyright © 1996, Texas Instruments Incorporated

# TLC548C, TLC548I, TLC549C, TLC549I 8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL

SLAS067C – NOVEMBER 1983 – REVISED SEPTEMBER 1996

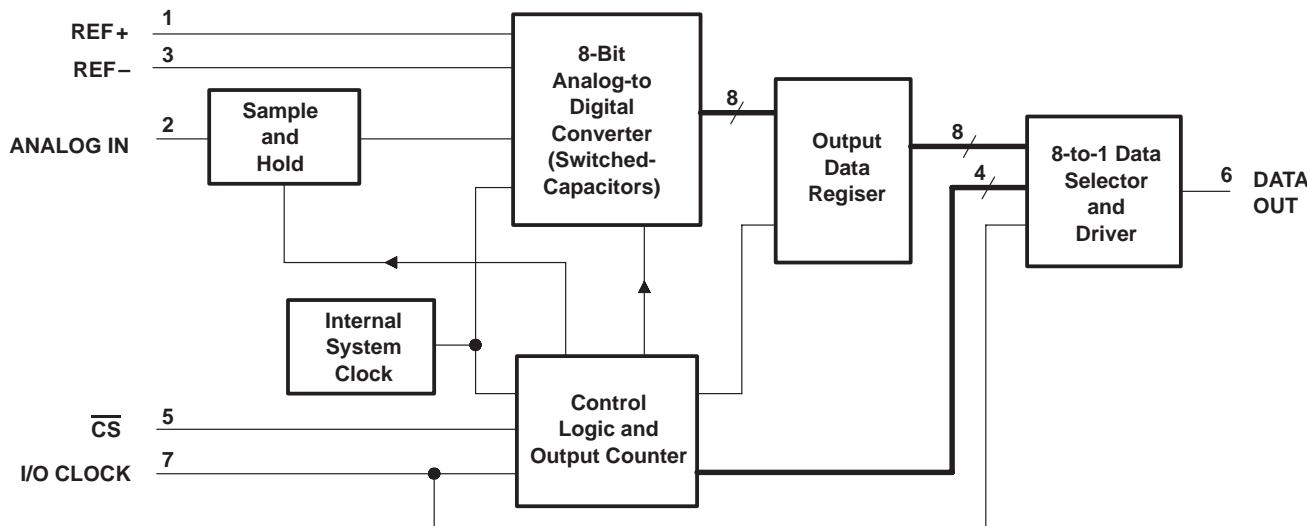
## description (continued)

Operation of the TLC548 and the TLC549 is very similar to that of the more complex TLC540 and TLC541 devices; however, the TLC548 and TLC549 provide an on-chip system clock that operates typically at 4 MHz and requires no external components. The on-chip system clock allows internal device operation to proceed independently of serial input/output data timing and permits manipulation of the TLC548 and TLC549 as desired for a wide range of software and hardware requirements. The I/O CLOCK together with the internal system clock allow high-speed data transfer and conversion rates of 45 500 conversions per second for the TLC548, and 40 000 conversions per second for the TLC549.

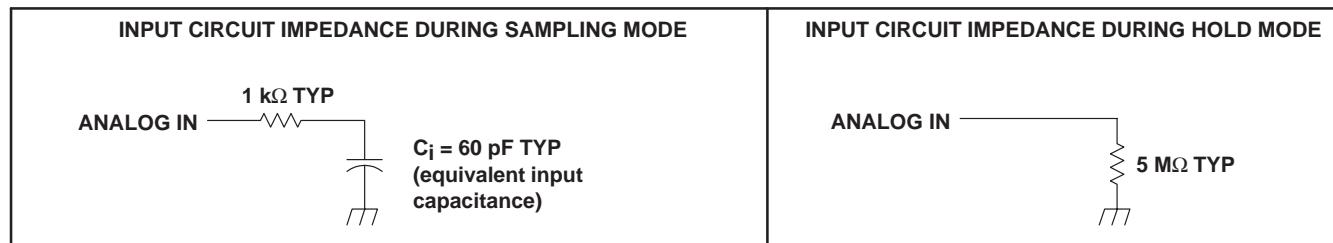
Additional TLC548 and TLC549 features include versatile control logic, an on-chip sample-and-hold circuit that can operate automatically or under microprocessor control, and a high-speed converter with differential high-impedance reference voltage inputs that ease ratiometric conversion, scaling, and circuit isolation from logic and supply noises. Design of the totally switched-capacitor successive-approximation converter circuit allows conversion with a maximum total error of  $\pm 0.5$  least significant bit (LSB) in less than 17  $\mu$ s.

The TLC548C and TLC549C are characterized for operation from 0°C to 70°C. The TLC548I and TLC549I are characterized for operation from -40°C to 85°C.

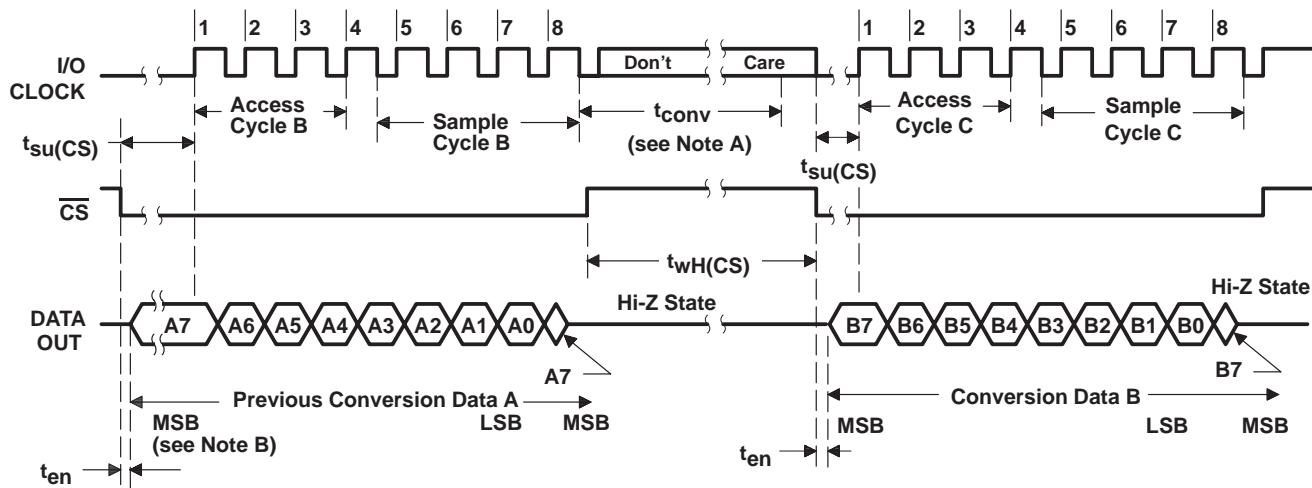
## functional block diagram



## typical equivalent inputs



### operating sequence



NOTES: A. The conversion cycle, which requires 36 internal system clock periods (17  $\mu$ s maximum), is initiated with the eighth I/O clock pulse trailing edge after CS goes low for the channel whose address exists in memory at the time.  
 B. The most significant bit (A7) is automatically placed on the DATA OUT bus after CS is brought low. The remaining seven bits (A6–A0) are clocked out on the first seven I/O clock falling edges. B7–B0 follows in the same manner.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $V_{CC}$ (see Note 1)	.....	6.5 V
Input voltage range at any input	.....	-0.3 V to $V_{CC}$ + 0.3 V
Output voltage range	.....	-0.3 V to $V_{CC}$ + 0.3 V
Peak input current range (any input)	.....	$\pm 10$ mA
Peak total input current range (all inputs)	.....	$\pm 30$ mA
Operating free-air temperature range, $T_A$ (see Note 2):	TLC548C, TLC549C	0°C to 70°C
	TLC548I, TLC549I	-40°C to 85°C
Storage temperature range, $T_{stg}$	.....	-65°C to 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	.....	260°C

NOTES: 1. All voltage values are with respect to the network ground terminal with the REF- and GND terminals connected together, unless otherwise noted.  
 2. The D package is not recommended below -40°C.

**TLC548C, TLC548I, TLC549C, TLC549I**  
**8-BIT ANALOG-TO-DIGITAL CONVERTERS**  
**WITH SERIAL CONTROL**

SLAS067C – NOVEMBER 1983 – REVISED SEPTEMBER 1996

**recommended operating conditions**

	TLC548			TLC549			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$	3	5	6	3	5	6	V
Positive reference voltage, $V_{ref+}$ (see Note 3)	2.5	$V_{CC}$	$V_{CC}+0.1$	2.5	$V_{CC}$	$V_{CC}+0.1$	V
Negative reference voltage, $V_{ref-}$ (see Note 3)	-0.1	0	2.5	-0.1	0	2.5	V
Differential reference voltage, $V_{ref+} - V_{ref-}$ (see Note 3)	1	$V_{CC}$	$V_{CC}+0.2$	1	$V_{CC}$	$V_{CC}+0.2$	V
Analog input voltage (see Note 3)	0	$V_{CC}$	$V_{CC}$	0	$V_{CC}$	$V_{CC}$	V
High-level control input voltage, $V_{IH}$ (for $V_{CC} = 4.75$ V to 5.5 V)	2			2			V
Low-level control input voltage, $V_{IL}$ (for $V_{CC} = 4.75$ V to 5.5 V)			0.8			0.8	V
Input/output clock frequency, $f_{clock(I/O)}$ (for $V_{CC} = 4.75$ V to 5.5 V)	0	2.048		0	1.1		MHz
Input/output clock high, $t_{WH}(I/O)$ (for $V_{CC} = 4.75$ V to 5.5 V)	200			404			ns
Input/output clock low, $t_{WL}(I/O)$ (for $V_{CC} = 4.75$ V to 5.5 V)	200			404			ns
Input/output clock transition time, $t_t(I/O)$ (for $V_{CC} = 4.75$ V to 5.5 V) (see Note 4 and Operating Sequence)		100			100		ns
Duration of $\overline{CS}$ input high state during conversion, $t_{WH}(CS)$ (for $V_{CC} = 4.75$ V to 5.5 V) (see Operating Sequence)	17			17			μs
Setup time, $CS$ low before first I/O CLOCK, $t_{su}(CS)$ (for $V_{CC} = 4.75$ V to 5.5 V) (see Note 5)	1.4			1.4			μs
TLC548C, TLC549C	0	70		0	70		°C
TLC548I, TLC549I	-40	85		-40	85		

NOTES: 3. Analog input voltages greater than that applied to  $REF+$  convert to all ones (11111111), while input voltages less than that applied to  $REF-$  convert to all zeros (00000000). For proper operation, the positive reference voltage  $V_{ref+}$ , must be at least 1 V greater than the negative reference voltage,  $V_{ref-}$ . In addition, unadjusted errors may increase as the differential reference voltage,  $V_{ref+} - V_{ref-}$ , falls below 4.75 V.

4. This is the time required for the I/O CLOCK input signal to fall from  $V_{IH}$  min to  $V_{IL}$  max or to rise from  $V_{IL}$  max to  $V_{IH}$  min. In the vicinity of normal room temperature, the devices function with input clock transition time as slow as 2 μs for remote data acquisition applications in which the sensor and the ADC are placed several feet away from the controlling microprocessor.

5. To minimize errors caused by noise at the  $CS$  input, the internal circuitry waits for two rising edges and one falling edge of internal system clock after  $CS \downarrow$  before responding to control input signals. This  $CS$  setup time is given by the  $t_{en}$  and  $t_{su}(CS)$  specifications.

**TLC548C, TLC548I, TLC549C, TLC549I**  
**8-BIT ANALOG-TO-DIGITAL CONVERTERS**  
**WITH SERIAL CONTROL**

SLAS067C – NOVEMBER 1983 – REVISED SEPTEMBER 1996

**electrical characteristics over recommended operating free-air temperature range,  
 $V_{CC} = V_{ref+} = 4.75$  V to 5.5 V,  $f_{clock(I/O)} = 2.048$  MHz for TLC548 or 1.1 MHz for TLC549  
(unless otherwise noted)**

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
$V_{OH}$	High-level output voltage	$V_{CC} = 4.75$ V, $I_{OH} = -360$ $\mu$ A	2.4			V
$V_{OL}$	Low-level output voltage	$V_{CC} = 4.75$ V, $I_{OL} = 3.2$ mA		0.4		V
$I_{OZ}$	High-impedance off-state output current	$V_O = V_{CC}$ , $\overline{CS}$ at $V_{CC}$		10		$\mu$ A
		$V_O = 0$ , $\overline{CS}$ at $V_{CC}$		-10		
$I_{IH}$	High-level input current, control inputs	$V_I = V_{CC}$		0.005	2.5	$\mu$ A
$I_{IL}$	Low-level input current, control inputs	$V_I = 0$		-0.005	-2.5	$\mu$ A
$I_{I(on)}$	Analog channel on-state input current during sample cycle	Analog input at $V_{CC}$	0.4	1		$\mu$ A
		Analog input at 0 V	-0.4	-1		
$I_{CC}$	Operating supply current	$\overline{CS}$ at 0 V		1.8	2.5	mA
$I_{CC} + I_{ref}$	Supply and reference current	$V_{ref+} = V_{CC}$		1.9	3	mA
$C_i$	Input capacitance	Analog inputs		7	55	$pF$
		Control inputs		5	15	

**operating characteristics over recommended operating free-air temperature range,  
 $V_{CC} = V_{ref+} = 4.75$  V to 5.5 V,  $f_{clock(I/O)} = 2.048$  MHz for TLC548 or 1.1 MHz for TLC549  
(unless otherwise noted)**

PARAMETER	TEST CONDITIONS	TLC548			TLC549			UNIT
		MIN	TYP†	MAX	MIN	TYP†	MAX	
$E_L$	Linearity error		$\pm 0.5$			$\pm 0.5$		LSB
$E_{ZS}$	Zero-scale error		$\pm 0.5$			$\pm 0.5$		LSB
$E_{FS}$	Full-scale error		$\pm 0.5$			$\pm 0.5$		LSB
Total unadjusted error	See Note 8		$\pm 0.5$			$\pm 0.5$		LSB
$t_{conv}$	Conversion time	See Operating Sequence	8	17	12	17	$\mu$ s	
	Total access and conversion time	See Operating Sequence	12	22	19	25	$\mu$ s	
$t_a$	Channel acquisition time (sample cycle)	See Operating Sequence		4		4		I/O clock cycles
$t_v$	Time output data remains valid after I/O CLOCK $\downarrow$		10		10			ns
$t_d$	Delay time to data output valid	I/O CLOCK $\downarrow$		200		400		ns
$t_{en}$	Output enable time			1.4		1.4	$\mu$ s	
$t_{dis}$	Output disable time			150		150		ns
$t_{r(bus)}$	Data bus rise time	See Figure 1		300		300		ns
$t_{f(bus)}$	Data bus fall time			300		300		ns

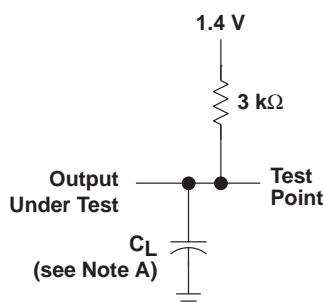
† All typicals are at  $V_{CC} = 5$  V,  $T_A = 25^\circ$ C.

NOTES: 6. Linearity error is the deviation from the best straight line through the A/D transfer characteristics.  
7. Zero-scale error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.  
8. Total unadjusted error is the sum of linearity, zero-scale, and full-scale errors.

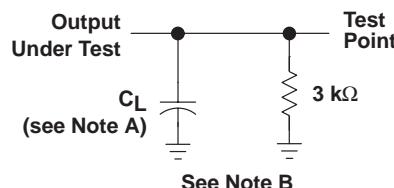
**TLC548C, TLC548I, TLC549C, TLC549I  
8-BIT ANALOG-TO-DIGITAL CONVERTERS  
WITH SERIAL CONTROL**

SLAS067C – NOVEMBER 1983 – REVISED SEPTEMBER 1996

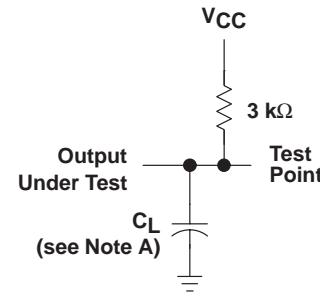
**PARAMETER MEASUREMENT INFORMATION**



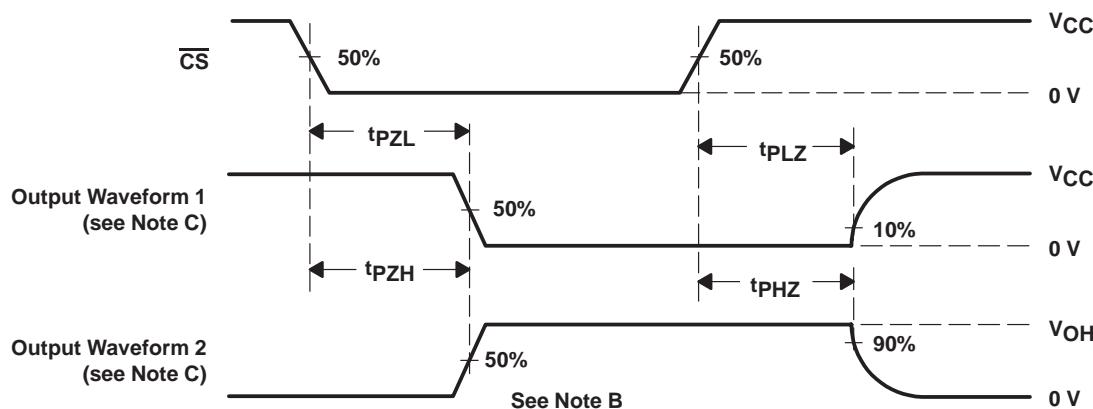
LOAD CIRCUIT FOR  
 $t_d$ ,  $t_r$ , AND  $t_f$



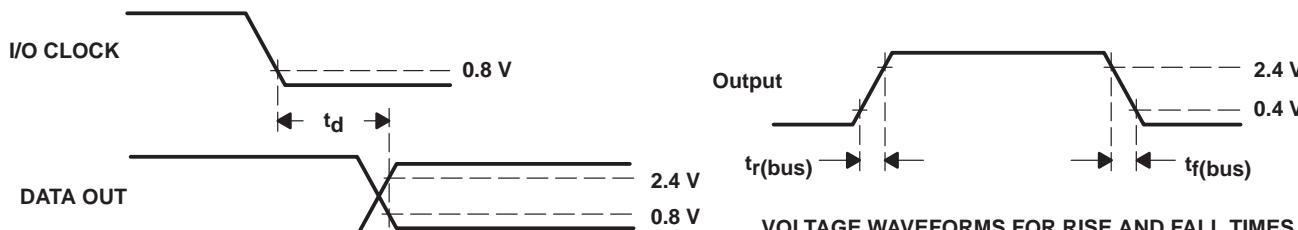
LOAD CIRCUIT FOR  
 $t_{PZH}$  AND  $t_{PHZ}$



LOAD CIRCUIT FOR  
 $t_{PZL}$  AND  $t_{PLZ}$



VOLTAGE WAVEFORMS FOR ENABLE AND DISABLE TIMES



VOLTAGE WAVEFORMS FOR DELAY TIME

NOTES: A.  $C_L = 50$  pF for TLC548 and  $100$  pF for TLC549;  $C_L$  includes jig capacitance.  
B.  $t_{en} = t_{PZH}$  or  $t_{PZL}$ ;  $t_{dis} = t_{PHZ}$  or  $t_{PLZ}$ .  
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

**Figure 1. Load Circuits and Voltage Waveforms**

## APPLICATIONS INFORMATION

### simplified analog input analysis

Using the equivalent circuit in Figure 2, the time required to charge the analog input capacitance from 0 to  $V_S$  within 1/2 LSB can be derived as follows:

The capacitance charging voltage is given by

$$V_C = V_S (1 - e^{-t_C/R_t C_i}) \quad (1)$$

where

$$R_t = R_s + r_i$$

The final voltage to 1/2 LSB is given by

$$V_C (1/2 \text{ LSB}) = V_S - (V_S/512) \quad (2)$$

Equating equation 1 to equation 2 and solving for time  $t_C$  gives

$$V_S - (V_S/512) = V_S (1 - e^{-t_C/(R_t C_i)}) \quad (3)$$

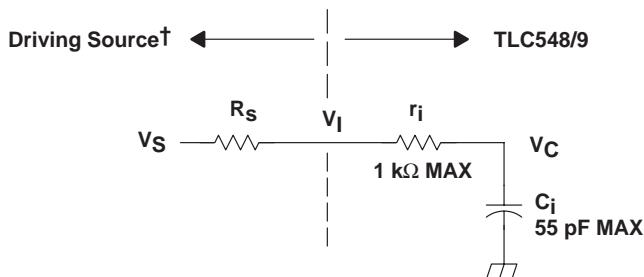
and

$$t_C (1/2 \text{ LSB}) = R_t \times C_i \times \ln(512) \quad (4)$$

Therefore, with the values given the time for the analog input signal to settle is

$$t_C (1/2 \text{ LSB}) = (R_s + 1 \text{ k}\Omega) \times 60 \text{ pF} \times \ln(512) \quad (5)$$

This time must be less than the converter sample time shown in the timing diagrams.



$V_I$  = Input Voltage at ANALOG IN  
 $V_S$  = External Driving Source Voltage  
 $R_s$  = Source Resistance  
 $r_i$  = Input Resistance  
 $C_i$  = Input Capacitance

† Driving source requirements:

- Noise and distortion for the source must be equivalent to the resolution of the converter.
- $R_s$  must be real at the input frequency.

**Figure 2. Equivalent Input Circuit Including the Driving Source**

# TLC548C, TLC548I, TLC549C, TLC549I 8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL

SLAS067C – NOVEMBER 1983 – REVISED SEPTEMBER 1996

## PRINCIPLES OF OPERATION

The TLC548 and TLC549 are each complete data acquisition systems on a single chip. Each contains an internal system clock, sample-and-hold function, 8-bit A/D converter, data register, and control logic circuitry. For flexibility and access speed, there are two control inputs: I/O CLOCK and chip select ( $\overline{CS}$ ). These control inputs and a TTL-compatible 3-state output facilitate serial communications with a microprocessor or minicomputer. A conversion can be completed in 17  $\mu$ s or less, while complete input-conversion-output cycles can be repeated in 22  $\mu$ s for the TLC548 and in 25  $\mu$ s for the TLC549.

The internal system clock and I/O CLOCK are used independently and do not require any special speed or phase relationships between them. This independence simplifies the hardware and software control tasks for the device. Due to this independence and the internal generation of the system clock, the control hardware and software need only be concerned with reading the previous conversion result and starting the conversion by using the I/O clock. In this manner, the internal system clock drives the “conversion crunching” circuitry so that the control hardware and software need not be concerned with this task.

When  $\overline{CS}$  is high, DATA OUT is in a high-impedance condition and I/O CLOCK is disabled. This  $\overline{CS}$  control function allows I/O CLOCK to share the same control logic point with its counterpart terminal when additional TLC548 and TLC549 devices are used. This also serves to minimize the required control logic terminals when using multiple TLC548 and TLC549 devices.

The control sequence has been designed to minimize the time and effort required to initiate conversion and obtain the conversion result. A normal control sequence is:

1.  $\overline{CS}$  is brought low. To minimize errors caused by noise at  $\overline{CS}$ , the internal circuitry waits for two rising edges and then a falling edge of the internal system clock after a  $\overline{CS}\downarrow$  before the transition is recognized. However, upon a  $\overline{CS}$  rising edge, DATA OUT goes to a high-impedance state within the specified  $t_{dis}$  even though the rest of the integrated circuitry does not recognize the transition until the specified  $t_{su}(CS)$  has elapsed. This technique protects the device against noise when used in a noisy environment. The most significant bit (MSB) of the previous conversion result initially appears on DATA OUT when  $\overline{CS}$  goes low.
2. The falling edges of the first four I/O CLOCK cycles shift out the second, third, fourth, and fifth most significant bits of the previous conversion result. The on-chip sample-and-hold function begins sampling the analog input after the fourth high-to-low transition of I/O CLOCK. The sampling operation basically involves the charging of internal capacitors to the level of the analog input voltage.
3. Three more I/O CLOCK cycles are then applied to the I/O CLOCK terminal and the sixth, seventh, and eighth conversion bits are shifted out on the falling edges of these clock cycles.
4. The final (the eighth) clock cycle is applied to I/O CLOCK. The on-chip sample-and-hold function begins the hold operation upon the high-to-low transition of this clock cycle. The hold function continues for the next four internal system clock cycles, after which the holding function terminates and the conversion is performed during the next 32 system clock cycles, giving a total of 36 cycles. After the eighth I/O CLOCK cycle,  $\overline{CS}$  must go high or the I/O clock must remain low for at least 36 internal system clock cycles to allow for the completion of the hold and conversion functions.  $\overline{CS}$  can be kept low during periods of multiple conversion. When keeping  $\overline{CS}$  low during periods of multiple conversion, special care must be exercised to prevent noise glitches on the I/O CLOCK line. If glitches occur on I/O CLOCK, the I/O sequence between the microprocessor/controller and the device loses synchronization. When  $\overline{CS}$  is taken high, it must remain high until the end of conversion. Otherwise, a valid high-to-low transition of  $\overline{CS}$  causes a reset condition, which aborts the conversion in progress.

A new conversion may be started and the ongoing conversion simultaneously aborted by performing steps 1 through 4 before the 36 internal system clock cycles occur. Such action yields the conversion result of the previous conversion and not the ongoing conversion.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

**TLC548C, TLC548I, TLC549C, TLC549I  
8-BIT ANALOG-TO-DIGITAL CONVERTERS  
WITH SERIAL CONTROL**

SLAS067C – NOVEMBER 1983 – REVISED SEPTEMBER 1996

---

## **PRINCIPLES OF OPERATION**

For certain applications, such as strobing applications, it is necessary to start conversion at a specific point in time. This device accommodates these applications. Although the on-chip sample-and-hold function begins sampling upon the high-to-low transition of the fourth I/O CLOCK cycle, the hold function does not begin until the high-to-low transition of the eighth I/O CLOCK cycle, which should occur at the moment when the analog signal must be converted. The TLC548 and TLC549 continue sampling the analog input until the high-to-low transition of the eighth I/O CLOCK pulse. The control circuitry or software then immediately lowers I/O CLOCK and starts the holding function to hold the analog signal at the desired point in time and starts the conversion.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TLC548CD	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC548CDR	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC548CDRG4	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC548CP	ACTIVE	PDIP	P	8		Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC548CPE4	ACTIVE	PDIP	P	8		Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC548ID	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC548IDR	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC548IDRG4	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC548IP	ACTIVE	PDIP	P	8		Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC548IPE4	ACTIVE	PDIP	P	8		Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC549CD	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549CDG4	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549CDR	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549CDRG4	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549CP	ACTIVE	PDIP	P	8		Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC549CPE4	ACTIVE	PDIP	P	8		Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC549ID	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549IDG4	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549IDR	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549IDRG4	ACTIVE	SOIC	D	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549IP	ACTIVE	PDIP	P	8		Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC549IPE4	ACTIVE	PDIP	P	8		Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC549IPS	ACTIVE	SO	PS	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549IPSG4	ACTIVE	SO	PS	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549IPSR	ACTIVE	SO	PS	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TLC549IPSRG4	ACTIVE	SO	PS	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC549MP	OBsolete	PDIP	P	8		TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

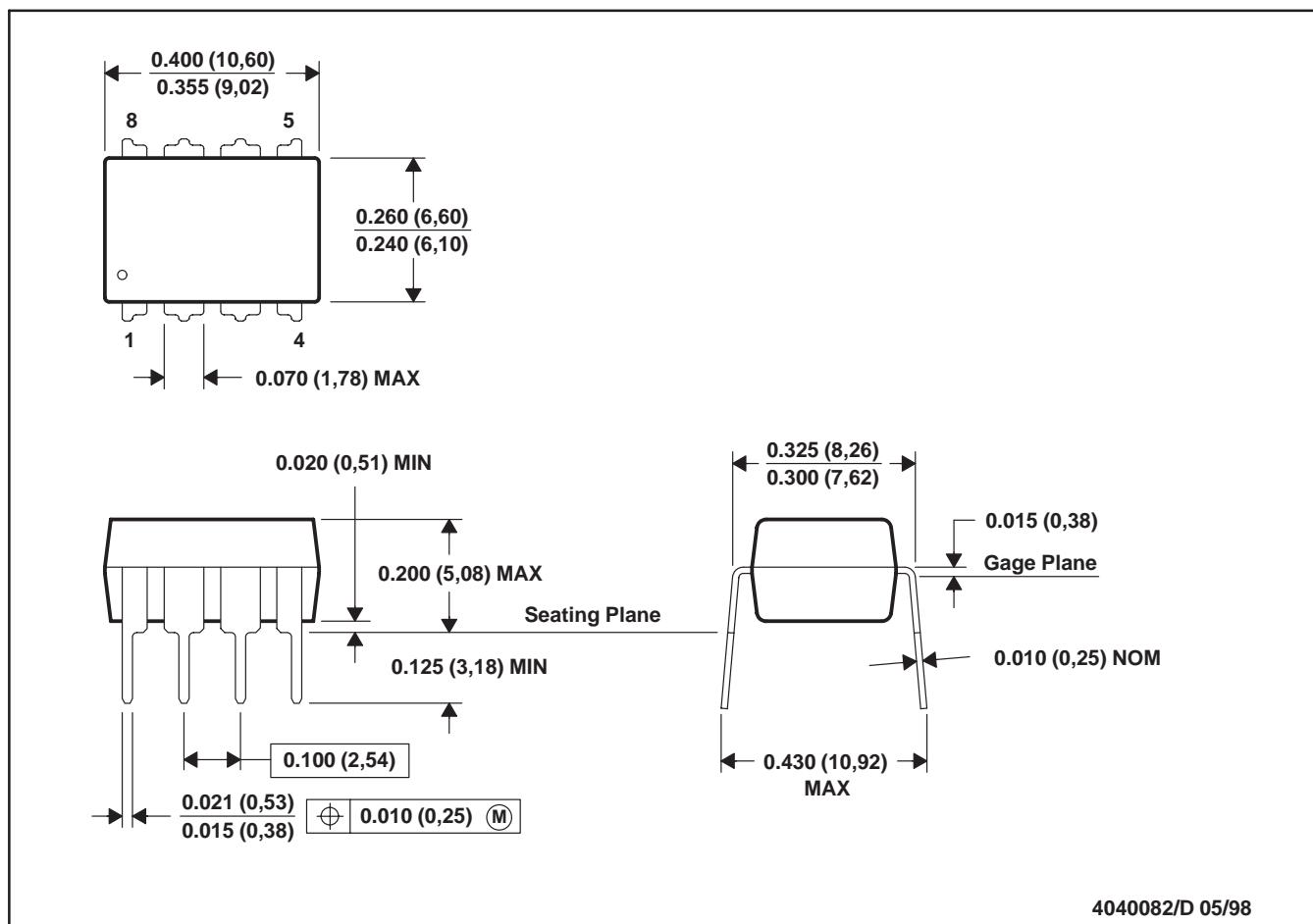
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE

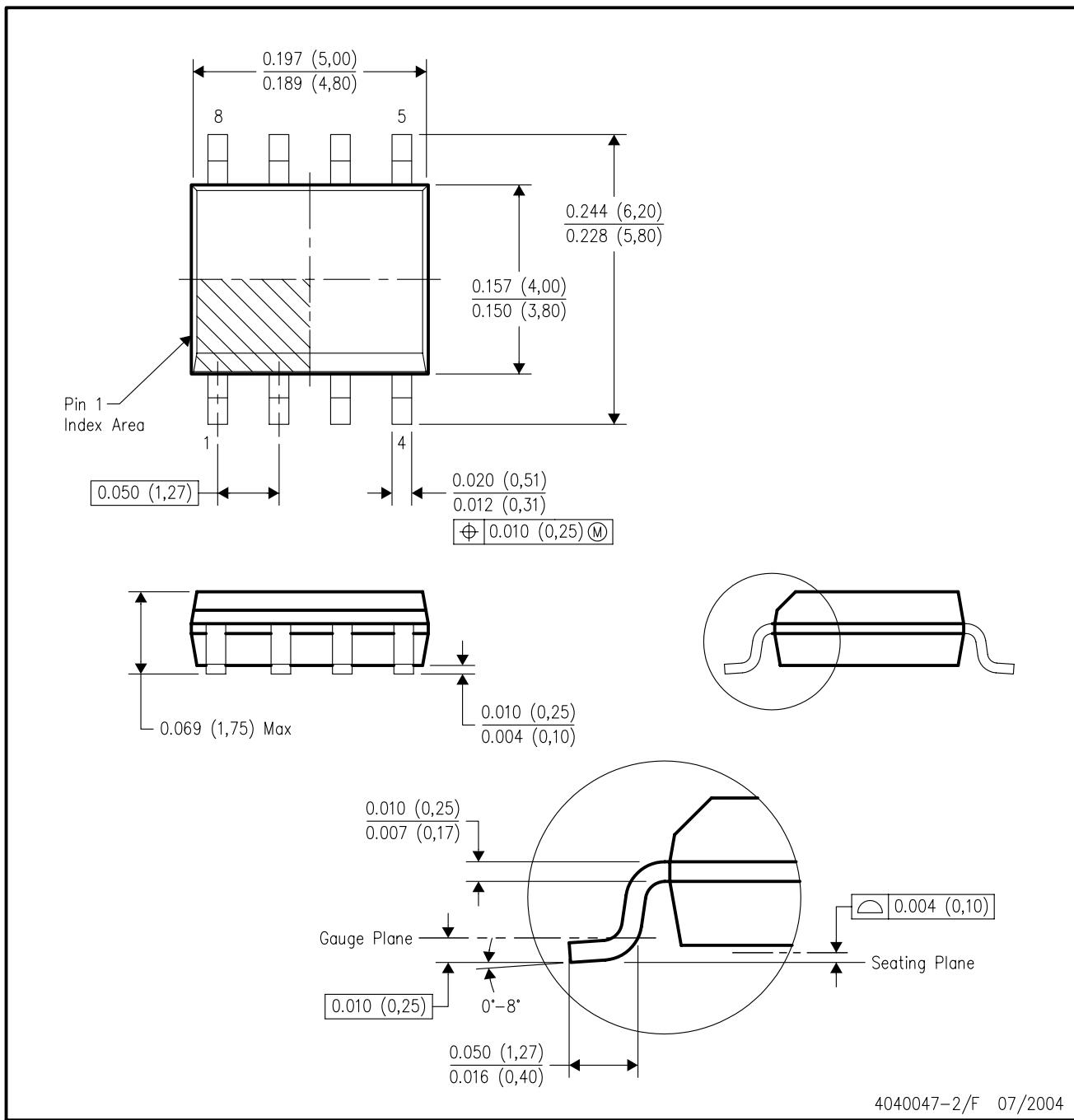


NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-001

For the latest package information, go to [http://www.ti.com/sc/docs/package/pkg\\_info.htm](http://www.ti.com/sc/docs/package/pkg_info.htm)

## D (R-PDSO-G8)

## PLASTIC SMALL-OUTLINE PACKAGE



4040047-2/F 07/2004

NOTES:

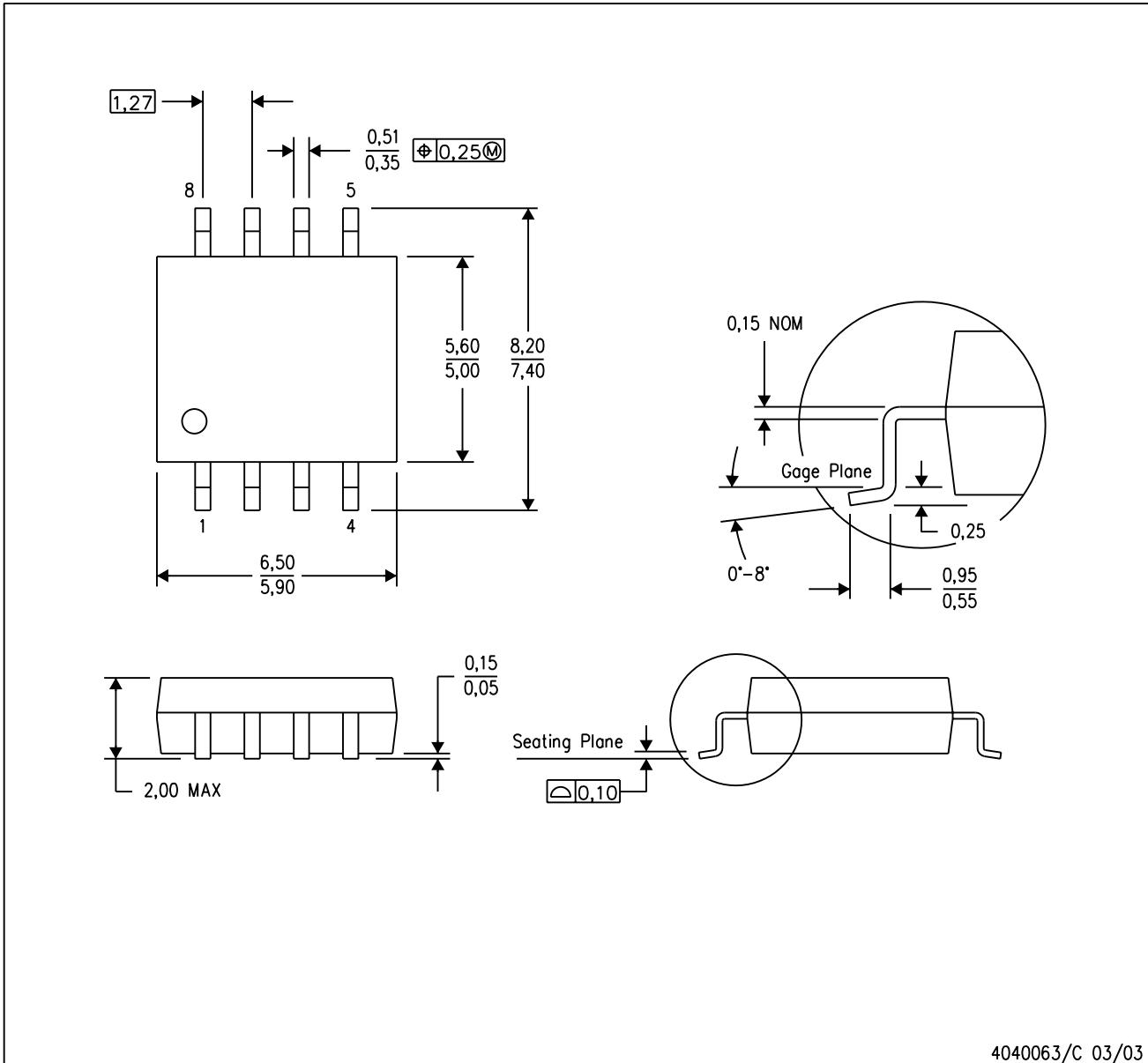
- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0.15).
- Falls within JEDEC MS-012 variation AA.

---

## MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

<b>Products</b>		<b>Applications</b>	
Amplifiers	amplifier.ti.com	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	dataconverter.ti.com	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DSP	dsp.ti.com	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	interface.ti.com	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	logic.ti.com	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	power.ti.com	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	microcontroller.ti.com	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2006, Texas Instruments Incorporated